WNSC2D201200



### Silicon Carbide Diode

Rev.01 - 21 June 2022

**Product data sheet** 

### **1. General description**

Silicon Carbide Schottky diode in a TO220-2L plastic package, designed for high frequency switched-mode power supplies.



### 2. Features and benefits

- Highly stable switching performance
- High forward surge capability I<sub>FSM</sub>
- Extremely fast reverse recovery time
- · Superior in efficiency to Silicon Diode alternatives
- · Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T<sub>i(max)</sub> = 175 °C)

### 3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

# 4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute	Absolute maximum rating						
V <sub>RRM</sub> repetitive peak reverse voltage				1200		V	
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 146 °C; Fig. 1; Fig. 2; Fig. 3		20		A	
Tj	junction temperature			-	-55 to 17	5	°C
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	Static characteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 20 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.45	1.65	V
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	1.95	2.30	V
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 175 °C; <u>Fig. 5</u>		-	2.10	2.60	V
Dynamic	Dynamic characteristics						
Q <sub>r</sub>	recovered charge	$I_F = 20 \text{ A}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s}; \text{ V}_R = 400 \text{ V};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	45	-	nC

# 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	К — Ісі — А
2	А	anode	] / () \	K — — — A 001aaa020
mb	mb	mounting base; connected to cathode		

# 6. Ordering information

Table 3. Ordering information						
Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WNSC2D201200	TO220-2L	WNSC2D2012006Q	Tube	50	SOD59A	30-Mar-2015

# 7. Marking

Table 4. Marking codes				
Marking codes				
WNSC2D 201200				

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
$V_{\text{RRM}}$	repetitive peak reverse voltage			1200	V
$V_{\text{RWM}}$	crest working reverse voltage			1200	V
V <sub>R</sub>	reverse voltage	DC		1200	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5; square-wave pulse; T <sub>mb</sub> ≤ 146 °C; Fig. 1; Fig. 2; Fig. 3		20	A
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5; t <sub>p</sub> = 25 μs; T <sub>mb</sub> ≤ 146 °C; square-wave pulse		40	А
I <sub>FSM</sub>	non-repetitive peak	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		160	А
	forward current	$t_p$ = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse		1000	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	sine-wave pulse; T <sub>j(init)</sub> = 25 °C; t <sub>p</sub> = 10 ms		128	A <sup>2</sup> s
T <sub>stg</sub>	storage temperature			-55 to 175	°C
T <sub>j</sub>	junction temperature			-55 to 175	°C

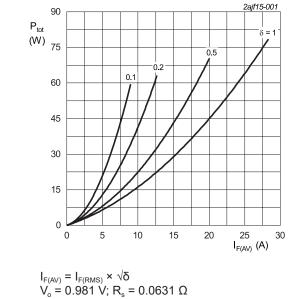


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

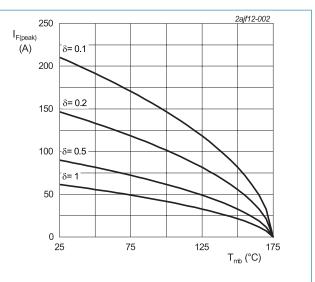
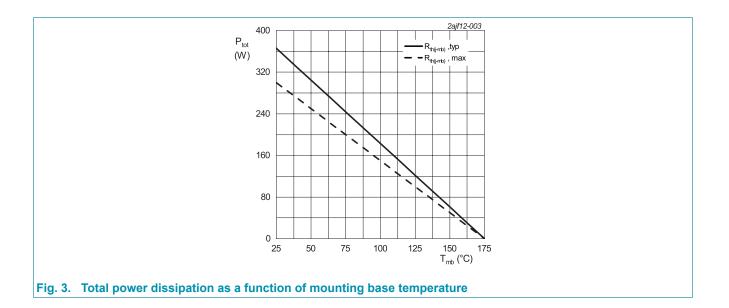


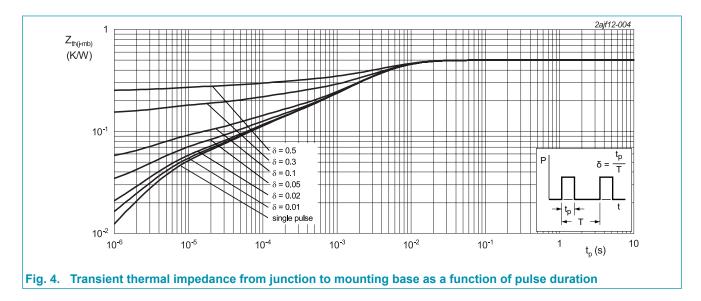
Fig. 2. Current derating as a function of mounting base temperature

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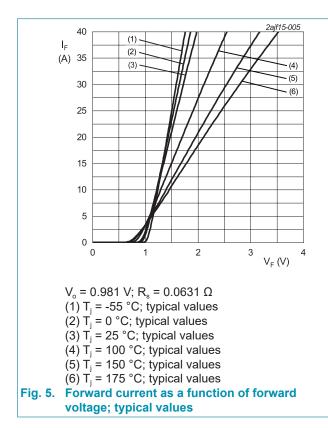
# 9. Thermal characteristics

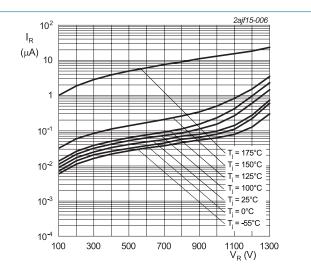
Table 6. Thermal characteristics							
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 4</u>		-	0.41	0.5	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air		-	40	-	K/W



## **10. Characteristics**

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
V <sub>F</sub>	forward current	I <sub>F</sub> = 20 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.45	1.65	V
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	1.95	2.30	V
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 175 °C; <u>Fig. 5</u>		-	2.10	2.60	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 1200 V; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>		-	1	100	μA
		V <sub>R</sub> = 1200 V; T <sub>j</sub> = 175 °C; <u>Fig. 6</u>		-	25	1000	μA
Dynamic	characteristics			,			
Q <sub>r</sub>	recovered charge	I <sub>F</sub> = 20 A; V <sub>R</sub> = 400 V; dI <sub>F</sub> /dt = 500 A/μs; T <sub>i</sub> = 25 °C; <u>Fig. 7</u>		-	45	-	nC
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 1 V; T <sub>j</sub> = 25 °C		-	950	-	pF
		f = 1 MHz; V <sub>R</sub> = 400 V; T <sub>j</sub> = 25 °C		-	86	-	pF
		f = 1 MHz; V <sub>R</sub> = 800 V; T <sub>j</sub> = 25 °C		-	64	-	pF
E <sub>as</sub>	non-repetitive $I_R = 5.3 \text{ A}; L = 10 \text{ mH}; T_{j(init)} = 25 \text{ °C}$ avalanche energy			140	-	-	mJ



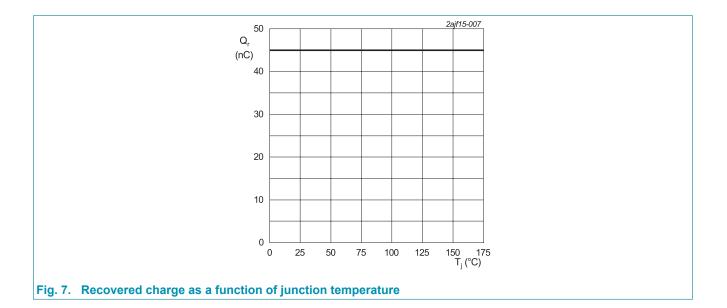




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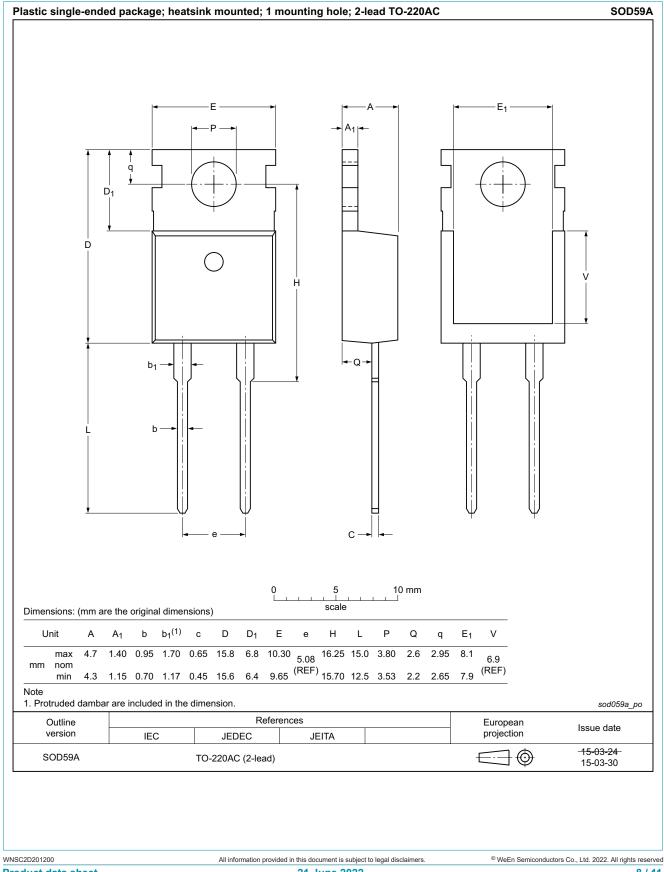
# WNSC2D201200

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### WNSC2D201200 Silicon Carbide Diode

### 11. Package outline



# WNSC2D201200

#### Silicon Carbide Diode

# 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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